Serial No. 10/074,293 Examiner; Andujar, Leonardo

## CLAIM AMENDMENTS

1. (currently amended) An on-chip inductor consisting of: at least one a dielectric laver; at least one a conductive winding on the at least one dielectric layer; and a P-well having a major surface parallel to a major surface of the dielectric layer; and a substrate having a major surface parallel to the major surface of the dielectric layer. 2. (currently amended) The on-chip inductor of claim 1 further consists of An on-chip inductor consisting of: a dielectric laver; a conductive winding on the dielectric layer; a P-well having a major surface parallel to a major surface of the dielectric layer; a field oxide having a major surface that is juxtaposed to the major surface of the P-well; and a substrate having a major surface parallel to the major surface of the dielectric layer. 3. (currently amended) The on-chip inductor of claim 1 further consists of wherein: the at least one dielectric layer including one layer; and the at least one conductive winding including is a spiral winding on the one layer.